or form 1449A/PTO Complete if Known RMATION DISCLOSURE **Application Number** 10/789,044 EMENT BY APPLICANT Filing Date February 27, 2004 as many sheets as necessary) First Named Inventor Ahn, Kie **Group Art Unit** 2829 Examiner Name Menz, Douglas Attorney Docket No: 1303.070US2 Sheet 1 of 4

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	First Named Inventor	Ahn, Kie			
	Group Art Unit	2829			
	Examiner Ņame	Menz, Douglas			
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Use as many sheets as necessary)	Filing Date	February 27, 2004		
	First Named Inventor	Ahn, Kie		
	Group Art Unit	2829		
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Use as many sheets as necessary)	Filing Date	February 27, 2004 Ahn, Kie		
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	Group Art Unit	2829		
	Examiner Name Menz, Douglas			
Sheet 4 of 4	Attorney Docket No: 1303.070US2			

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(Use as many sheets as necessary)	Filing Date	Even Date Herewith			
	First Named Inventor	Ahn, Kie			
· .	Group Art Unit	Unknown			
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	Filing Date	Even Date Herewith			
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	Group Art Unit	Unknown			
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	First Named Inventor	Ahn, Kie	
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	First Named Inventor	Ahn, Kie	
·	Group Art Unit	Unknown	
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	First Named Inventor	Ahn, Kie	
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